

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Linda A. Shekhawat	08/23/2007
Nachiket R. Raravikar	08/20/2007
RECEIVING PARTY DATA	
Name:	Intel Corporation
Street Address:	2200 Mission College Blvd.
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95052
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11845145
CORRESPONDENCE DATA	
Fax Number:	(612)677-3572
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	480-715-0655
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Correspondent Name:	Intel Corporation
Address Line 1:	c/o CPA Global
Address Line 2:	PO Box 52050
Address Line 4:	Minneapolis, MINNESOTA 55402
ATTORNEY DOCKET NUMBER:	P26002
NAME OF SUBMITTER:	Kenneth A. Nelson
Total Attachments: 3 source=P26002 Executed Assignment#page1.tif source=P26002 Executed Assignment#page2.tif	

CH \$40.00 11845145

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

LINDA SHEKHAWAT; NACHIKET R. RARAVIKAR

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent entitled:

THERMALLY AND ELECTRICALLY CONDUCTIVE STRUCTURE, METHOD OF APPLYING A CARBON COATING TO SAME, AND METHOD OF REDUCING A CONTACT RESISTANCE OF SAME

(I hereby authorize and request my attorney, associated with Customer Number 59796, to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on August 27, 2007 as
United States Application Number 11/845,145 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States applications;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Note to each inventor:
On the line below, please
enter the date on which you
signed the accompanying
"Declaration and Power of
Attorney".

<u>Linda A. Shekharat</u> LINDA A. SHEKHAWAT	<u>8/23/07</u> (Today's Date)	<u>8/23/07</u> (Date of Declaration)
<u>NACHIKET R. KARAVIKAR</u>	<u> </u> (Today's Date)	<u> </u> (Date of Declaration)

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Note to each inventor:
On the line below, please
enter the date on which you
signed the accompanying
"Declaration and Power of
Attorney".

LINDA SHEKHAWAT

(Today's Date)

(Date of Declaration)

As per lead

NACHIKET R. KARAVIKAR

AUG 20, 2007

(Today's Date)

(Date of Declaration)